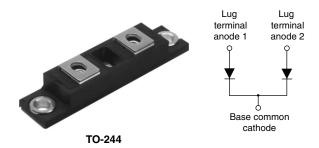


# Vishay High Power Products

# HEXFRED® Ultrafast Soft Recovery Diode, 320 A



PRODUCT SUMMARY				
I <sub>F(AV)</sub>	320 A			
V <sub>R</sub>	400 V			
I <sub>F(DC)</sub> at T <sub>C</sub>	255 A at 85 °C			

#### **FEATURES**

- Very low Q<sub>rr</sub> and t<sub>rr</sub>
- · Lead (Pb)-free
- · Designed and qualified for industrial level



ROHS

#### **BENEFITS**

- · Reduced RFI and EMI
- · Reduced snubbing

#### **DESCRIPTION**

HEXFRED<sup>®</sup> diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dI/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	$V_{R}$		400	V	
		T <sub>C</sub> = 25 °C 420			
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 85 °C	255	۸	
		T <sub>C</sub> = 115 °C	160	Α	
Single pulse forward current	I <sub>FSM</sub>	Limited by junction temperature	1200		
Non-repetitive avalanche energy	E <sub>AS</sub>	$L = 100 \mu H$ , duty cycle limited by maximum $T_J$	1.4	mJ	
Maximum power dissipation P <sub>D</sub>		T <sub>C</sub> = 25 °C	625	W	
		T <sub>C</sub> = 100 °C	250	VV	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 150	°C	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	Ι <sub>R</sub> = 100 μΑ		400	-	-	
		I <sub>F</sub> = 160 A		-	1.10	1.35	V
Maximum forward voltage V <sub>FN</sub>	$V_{FM}$	I <sub>F</sub> = 320 A	See fig. 1	-	1.30	1.54	
		I <sub>F</sub> = 160 A, T <sub>J</sub> = 125 °C		-	1.00	1.20	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 125 °C, V <sub>R</sub> = 400 V See fig. 2		-	0.9	3	mA
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V See fig. 3		-	370	500	pF
Series inductance	L <sub>S</sub>	From top of terminal hole to mounting plane		-	5.0	-	nH

## HFA320NJ40CPbF

# Vishay High Power Products

#### HEXFRED® Ultrafast Soft Recovery Diode, 320 A



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		I <sub>F</sub> = 1.0 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> =		-	45	-	
Reverse recovery time See fig. 5	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		=	90	140	ns
occ fig. 5		T <sub>J</sub> = 125 °C		=	290	440	
Peak recovery current	I <sub>RRM</sub> -	T <sub>J</sub> = 25 °C		-	8.7	20	^
See fig. 6		IRRM	T <sub>J</sub> = 125 °C	$I_F = 160 \text{ A}$	-	18	30
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	$dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_R = 200 \text{ V}$	=	420	1100	nC
See fig. 7		T <sub>J</sub> = 125 °C		=	2600	7000	
Peak rate of recovery current	1 dl/200/M/dt H	T <sub>J</sub> = 25 °C		=	300	-	Δ/110
See fig. 8		T <sub>J</sub> = 125 °C		=	280	-	A/μs

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature	range	T <sub>J</sub> , T <sub>Stg</sub>	- 55	-	150	°C	
per le		-	-	-	0.19		
Thermal resistance, junction to case	per module	$R_{thJC}$	-	-	0.095	°C/W K/W	
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	-	0.10	-		
Woight			-	68	-	g	
Weight			-	2.4	-	OZ.	
Mounting towns	(1)		30 (3.4)	-	40 (4.6)	NI	
Mounting torque	center hole		12 (1.4)	-	18 (2.1)	N ⋅ m (lbf ⋅ in)	
Terminal torque			30 (3.4)	-	40 (4.6)	(151 * 111)	
Vertical pull 2" lever pull			-	-	80	lbf ⋅ in	
			-	-	35	ווויוטו	

#### Note

<sup>(1)</sup> Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to 10 lbf · in steps until desired or maximum torque limits are reached.





#### HEXFRED® Ultrafast Soft Recovery Diode, 320 A

## Vishay High Power Products

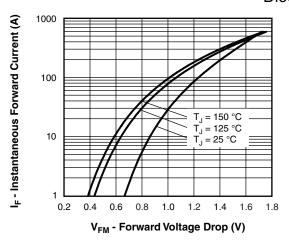


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)

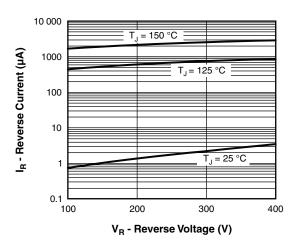


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)

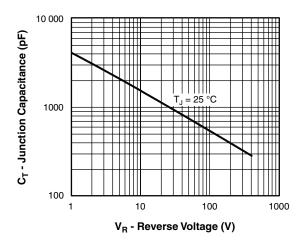


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

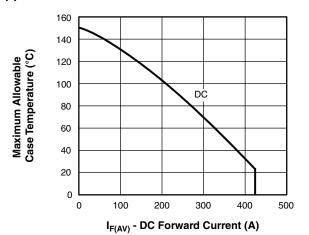


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)

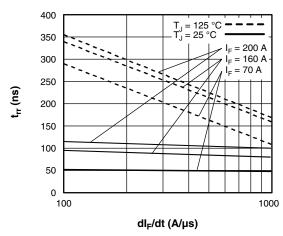


Fig. 5 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt (Per Leg)

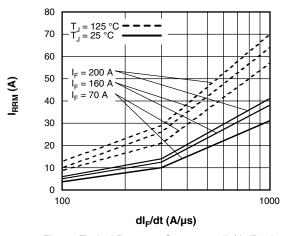


Fig. 6 - Typical Recovery Current vs. dI<sub>F</sub>/dt (Per Leg)

## HFA320NJ40CPbF

# Vishay High Power Products

#### HEXFRED® Ultrafast Soft Recovery Diode, 320 A



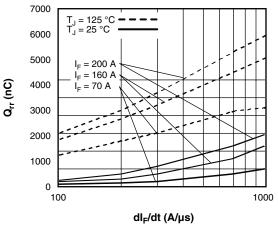


Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$  (Per Leg)

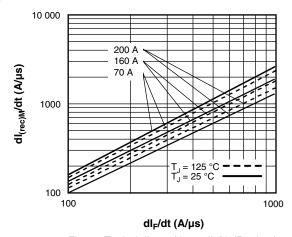


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$  (Per Leg)

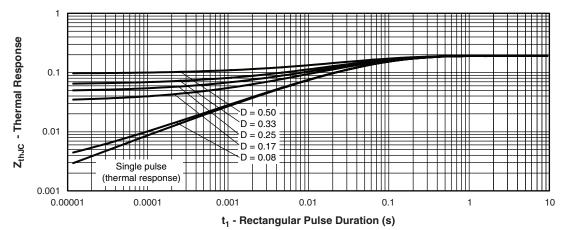


Fig. 9 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)



#### HEXFRED® Ultrafast Soft Recovery Diode, 320 A

# Vishay High Power Products

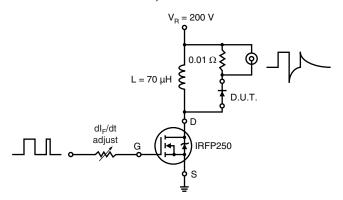
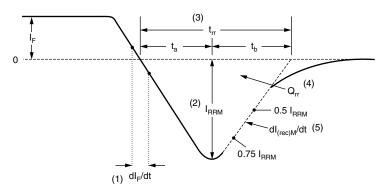


Fig. 10 - Reverse Recovery Parameter Test Circuit



- dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2)  $I_{RRM}$  peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_F$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  $Q_{rr}$  area under curve defined by  $t_{rr}$  and  $I_{RRM}$

$$Q_{rr} = \frac{t_{rr} x I_{RRM}}{2}$$

(5)  $dI_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 

Fig. 11 - Reverse Recovery Waveform and Definitions

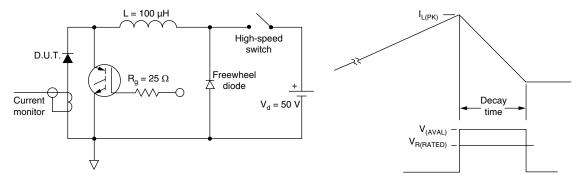


Fig. 12 - Avalanche Test Circuit and Waveforms

## HFA320NJ40CPbF

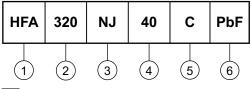
Vishay High Power Products

HEXFRED® Ultrafast Soft Recovery Diode, 320 A



#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - HEXFRED® family, electron irradiated

Average current rating

3 - NJ = TO-244

4 - Voltage rating (400 V)

5 - C = Common cathode

6 - Lead (Pb)-free

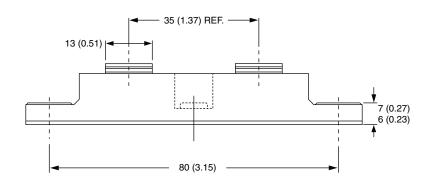
LINKS TO RELATED DOCUMENTS				
Dimensions	http://www.vishay.com/doc?95021			

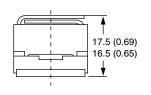


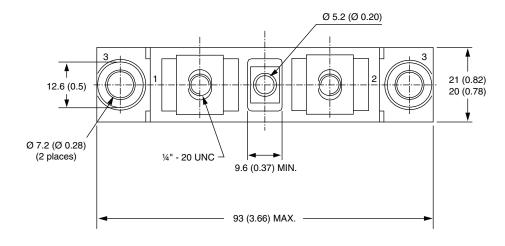
# Vishay Semiconductors

### **TO-244**

#### **DIMENSIONS** in millimeters (inches)









## **Legal Disclaimer Notice**

Vishay

#### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000